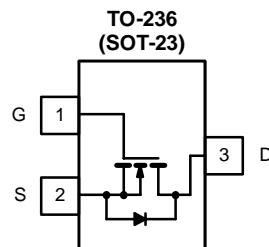


N-Channel 1.25-W, 2.5-V MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
20	0.060 @ $V_{GS} = 4.5$ V	2.4
	0.115 @ $V_{GS} = 2.5$ V	2.0



Ordering Information: Si2302ADS-T1

 Top View
 Si2302DS (2A)*
 *Marking Code

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter		Symbol	5 sec	Steady State	Unit	
Drain-Source Voltage	V_{DS}		20	± 8	V	
Gate-Source Voltage						
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a		I_D	2.4	2.1	A	
$T_A = 70^\circ\text{C}$			1.9	1.7		
Pulsed Drain Current ^a	I_{DM}		10		A	
Continuous Source Current (Diode Conduction) ^a			0.94	0.6		
Power Dissipation ^a	P_D		0.9	0.7	W	
$T_A = 70^\circ\text{C}$			0.57	0.46		
Operating Junction and Storage Temperature Range	T_J, T_{stg}		-55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \leq 5$ sec.	R_{thJA}	115	140	°C/W
	Steady State		140	175	

Notes

a. Surface Mounted on FR4 Board.

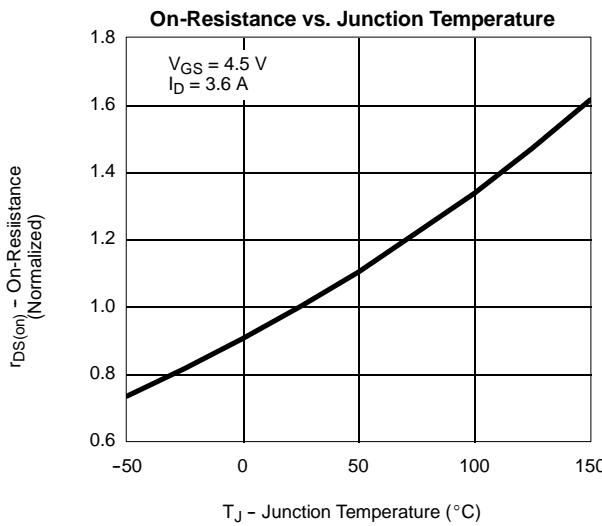
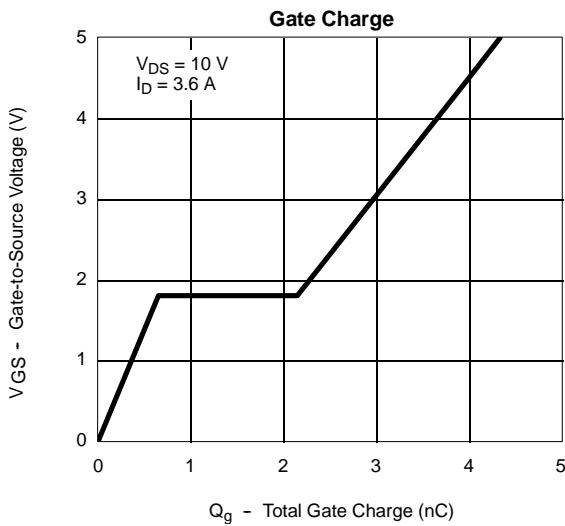
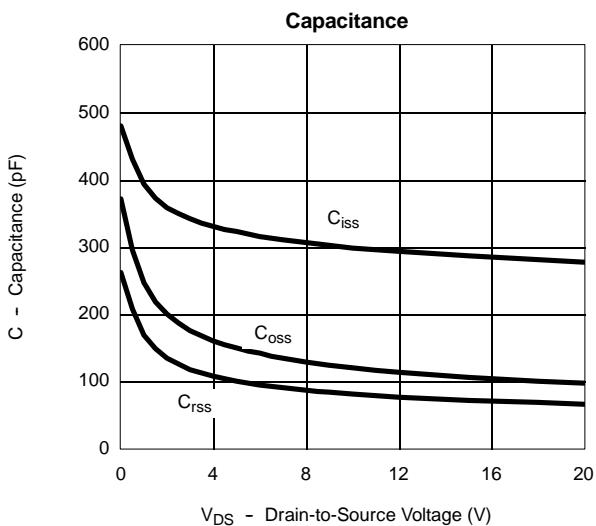
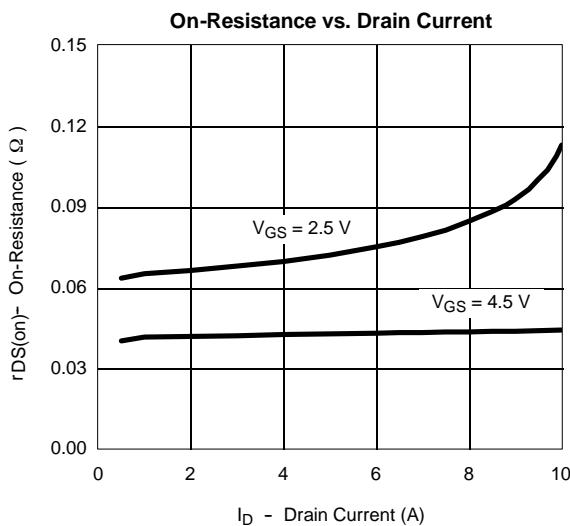
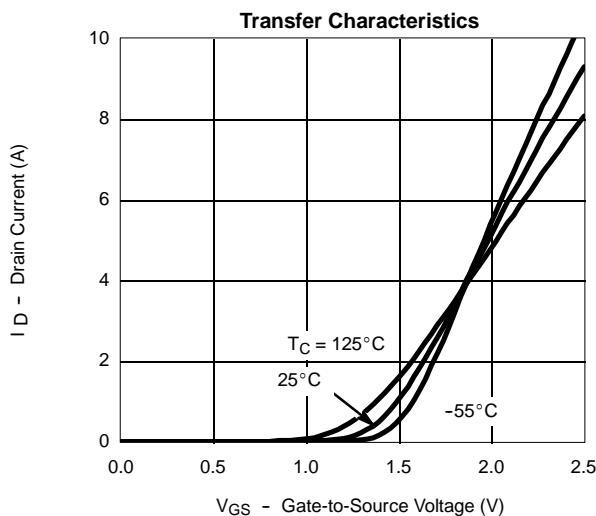
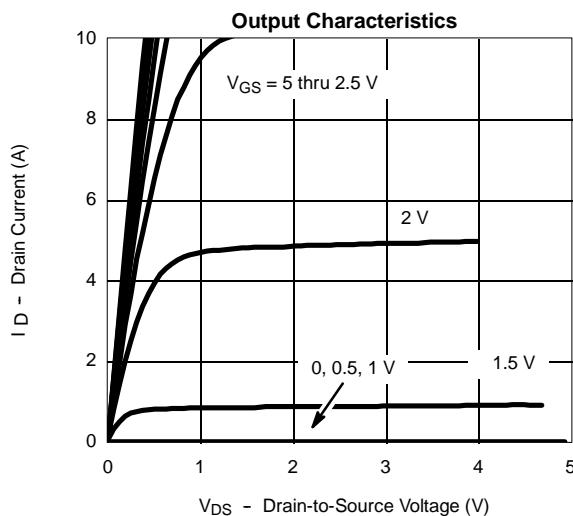
 For SPICE model information via the Worldwide Web: <http://www.vishay.com/www/product/spice.htm>

SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0 \text{ V}, I_D = 10 \mu\text{A}$	20			V
Gate-Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 50 \mu\text{A}$	0.65	0.95	1.2	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$			10	μA
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{DS} \geq 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	6			A
		$V_{DS} \geq 5 \text{ V}, V_{GS} = 2.5 \text{ V}$	4			
Drain-Source On-Resistance ^a	$r_{DS(\text{on})}$	$V_{GS} = 4.5 \text{ V}, I_D = 3.6 \text{ A}$		0.045	0.060 ^b	
		$V_{GS} = 2.5 \text{ V}, I_D = 3.1 \text{ A}$		0.070	0.115	Ω
Forward Transconductance ^a	g_{fs}	$V_{DS} = 5 \text{ V}, I_D = 3.6 \text{ A}$		8		S
Diode Forward Voltage	V_{SD}	$I_S = 0.94 \text{ A}, V_{GS} = 0 \text{ V}$		0.76	1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 3.6 \text{ A}$		4.0	10	nC
Gate-Source Charge	Q_{gs}			0.65		
Gate-Drain Charge	Q_{gd}			1.5		
Input Capacitance	C_{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		300		pF
Output Capacitance	C_{oss}			120		
Reverse Transfer Capacitance	C_{rss}			80		
Switching						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 10 \text{ V}, R_L = 2.8 \Omega$ $I_D \approx 3.6 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 6 \Omega$		7	15	ns
Rise Time	t_r			55	80	
Turn-Off Delay Time	$t_{d(off)}$			16	60	
Fall-Time	t_f			10	25	

Notes

- a. Pulse test: PW $\leq 300 \mu\text{s}$ duty cycle $\leq 2\%$.
- b. Effective for production 10/04.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)